

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	8	"134"/\$.ccls. and (wafer or semiconductor or substrate or workpiece) same plate near5 (hole or opening or nozzle) near5 (concentration or spacing or distance)	US-PGPUB; USPAT	OR	ON	2007/06/21 15:55
L3	18	"134"/\$.ccls. and (wafer or semiconductor or substrate or workpiece) same plate near8 (hole or opening or nozzle) near5 (concentration or spacing or distance)	US-PGPUB; USPAT	OR	ON	2007/06/21 14:37
L4	48	"134"/\$.ccls. and (wafer or semiconductor or substrate or workpiece) same plate near8 drain\$3	US-PGPUB; USPAT	OR	ON	2007/06/21 14:47
L5	7	"134"/\$.ccls. and (high near3 pressure) and (wafer or semiconductor or substrate or workpiece) same plate near8 drain\$3	US-PGPUB; USPAT	OR	ON	2007/06/21 14:49
L6	1824	"134"/\$.ccls. and (high near3 pressure) and (wafer or semiconductor or substrate or workpiece)	US-PGPUB; USPAT	OR	ON	2007/06/21 14:49
L7	995	"134"/\$.ccls. and (high near3 pressure) same (wafer or semiconductor or substrate or workpiece)	US-PGPUB; USPAT	OR	ON	2007/06/21 14:50
L8	188	"134"/\$.ccls. and (high near3 pressure near5 process\$3) same (wafer or semiconductor or substrate or workpiece)	US-PGPUB; USPAT	OR	ON	2007/06/21 14:50
L10	2	"6460554"	US-PGPUB; USPAT	OR	ON	2007/06/21 15:15
L11	5019	(wafer or semiconductor or substrate or workpiece) same plate near10 (nozzle or hole or opening) near10 (plurality or several or multiple)	US-PGPUB; USPAT	OR	ON	2007/06/21 15:17
L12	3953	(wafer or semiconductor or substrate or workpiece) same plate near6 (nozzle or hole or opening) near6 (plurality or several or multiple)	US-PGPUB; USPAT	OR	ON	2007/06/21 15:23

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L13	3667	(wafer or semiconductor or substrate or workpiece) same plate near6 (nozzle or hole or opening) near6 (plurality)	US-PGPUB; USPAT	OR	ON	2007/06/21 15:23
L14	1	"134"/902.ccls. and (wafer or semiconductor or substrate or workpiece) same plate near5 (hole or opening or nozzle) near5 (concentration or spacing or distance)	US-PGPUB; USPAT	OR	ON	2007/06/21 15:56
S1	350	"134"/\$.ccls. and (wafer or semiconductor or substrate or workpiece) same plate near5 (hole or opening)	US-PGPUB; USPAT	OR	ON	2007/06/21 00:07
S2	98	"134"/\$.ccls. and (wafer or semiconductor or substrate or workpiece) same plate near5 (hole or opening or nozzle) near5 (plurality or multiple)	US-PGPUB; USPAT	OR	ON	2007/06/21 15:12